Joint ERCOFTAC/EU-CTFF

European Drag Reduction and Flow Control Meeting – EDRFCM 2022

postponed to **6th - 9th September 2022**

Conservatoire National des Arts et Métiers
Paris, France

ERCOFTAC *Drag Reduction and Flow Control* special interest group (SIG 20) and EU H2020 MSCA-RISE *Control of Turbulent Friction Force* (CTFF) programme together with the Laboratoire Modélisation Mathématique et Numérique are pleased to announce the next European Drag Reduction and Flow Control Meeting (EDRFCM 2022) at Conservatoire National des Arts et Métiers, Paris.

Subjects:

All laminar & turbulent drag reduction and flow & noise control studies, including: riblets, surface roughness, compliant walls, polymer & surfactant additives, synthetic jets, super-hydrophobic surfaces, flexible structures, wall oscillations, travelling waves, flow separation control, plasma flow control and electro-magnetic control. There will be a special session on experimental and numerical control of near-wall turbulent structures for a reduction of turbulent friction force at conditions relevant to engineering practices.

Organisers:

- **Iraj Mortazavi**, Laboratoire Modélisation Mathématique et Numérique, iraj.mortazavi@lecnam.net
- **Kwing-So Choi**, University of Nottingham, kwing-so.choi@nottingham.ac.uk

Meeting Venue:

The meeting will be held at Conservatoire National des Arts et Métiers, which is situated in the heart of Paris, France.

Accommodation:

Suitable hotels and pensions nearby will be recommended by the organisers.

Revised Key Dates:

Abstract submission deadline: 6 June 2022
Notification of acceptance: 20 June 2022
Meeting: 6th - 9th September 2022

Registration:

The registration fee is expected to be around 200 EURO (reduced to 175 EURO for ERCOFTAC members), which includes lunch, coffee and tea over the 4-day meeting and a Book of Abstract. It also includes a ticket to a banquet to be held on the second evening of the meeting.

Scholarships:

We encourage the attendance of PhD students and young researchers. Limited funding is available to cover the registration fees. Applications for a scholarship can be made by sending an e-mail to the meeting organisers with a support letter from the supervisor.